

THYRISTORS FOR OVERVOLTAGE PROTECTION

- GLASS PASSIVATED CHIP
- HIGH STABILITY AND RELIABILITY
- HIGH SURGE CAPABILITY

Thread : 1/4" -28 UNF ; type N°
 M6 on request : type N° + suffix M



TO 48
(Metal)

DESCRIPTION

SCR designed for overvoltage protection in crowbar circuits.

ABSOLUTE RATINGS (limiting values)

| Symbol | Parameter | | Value | Unit |
|--------------------|---|----------------------------------|----------------------------|--------------------------------------|
| $I_{T(RMS)}$ | RMS on-state Current (1) | $T_c = 75\text{ }^\circ\text{C}$ | 25 | A |
| $I_{T(AV)}$ | Mean on-state Current (1) | $T_c = 75\text{ }^\circ\text{C}$ | 16 | A |
| I_{TSM} | Non Repetitive Surge Peak on-state Current (T_j initial = 25 °C) (2) | $t = 8.3\text{ ms}$ | 733 | A |
| | | $t = 10\text{ ms}$ | 700 | |
| I^2t | I^2t Value for Fusing | $t = 10\text{ ms}$ | 2450 | A ² s |
| I_{TM} | Non Repetitive Surge Peak on-state Current (T_j initial = 25 °C) (5) | $t = 250\text{ ms}$ | 145 | A |
| di/dt | Critical Rate of Rise of on-state Current (3) | | 100 | A/ μ s |
| T_{stg} T_j | Storage and Operating Junction Temperature Range | | - 40 to 150 - 40 to 125 | $^\circ\text{C}$ $^\circ\text{C}$ |

| Symbol | Parameter | TSP225 | TSP525 | TSP1025 | Unit |
|------------------------|---------------------------------------|--------|--------|---------|------|
| V_{DRM} V_{RRM} | Repetitive Peak off-state Voltage (4) | 25 | 50 | 100 | V |

(1) Single phase circuit, 180° conduction angle.

(2) Half sine wave.

(3) $I_G = 500\text{ mA}$ $di_G/dt = 1\text{ A}/\mu\text{s}$

(4) $T_j = 125\text{ }^\circ\text{C}$.

(5) Rectangular pulse

THERMAL RESISTANCES

| Symbol | Parameter | Value | Unit |
|---------------|----------------------------|-------|---------------------------|
| $R_{th(j-c)}$ | Junction-case for D.C. | 2.92 | $^\circ\text{C}/\text{W}$ |
| $R_{th(c-h)}$ | Contact (case to heatsink) | 0.40 | $^\circ\text{C}/\text{W}$ |

GATE CHARACTERISTICS (maximum values)

$P_{GM} = 60 \text{ W}$ ($t_p = 500 \mu\text{s}$)

$I_{FGM} = 10 \text{ A}$ ($t_p = 500 \mu\text{s}$)

$V_{RGM} = 5 \text{ V}$

$P_{G(AV)} = 1 \text{ W}$

$V_{FGM} = 15 \text{ V}$ ($t_p = 500 \mu\text{s}$)

ELECTRICAL CHARACTERISTICS

| Symbol | Test Conditions | | | Min. | Typ. | Max. | Unit |
|-----------|--|---|--|------------------------------------|------|------|------------------|
| I_{GT} | $T_j = 25 \text{ }^\circ\text{C}$ Pulse Duration > 20 μs | $V_D = 12 \text{ V}$ | $R_L = 33 \text{ } \Omega$ | | | 50 | mA |
| V_{GT} | $T_j = 25 \text{ }^\circ\text{C}$ Pulse Duration > 20 μs | $V_D = 12 \text{ V}$ | $R_L = 33 \text{ } \Omega$ | | | 1.5 | V |
| V_{GD} | $T_j = 125 \text{ }^\circ\text{C}$ | $V_D = V_{DRM}$ | $R_L = 3.3 \text{ k}\Omega$ | 0.2 | | | V |
| I_H | $T_j = 25 \text{ }^\circ\text{C}$ | $I_T = 500 \text{ mA}$ | Gate Open | | | 50 | mA |
| I_L | $T_j = 25 \text{ }^\circ\text{C}$ Pulse Duration > 20 μs | $V_D = 12 \text{ V}$ | $I_G = 100 \text{ mA}$ | | 50 | | mA |
| V_{TM} | $T_j = 25 \text{ }^\circ\text{C}$ | $I_{TM} = 140 \text{ A}$ | $t_p = 10 \text{ ms}$ | | | 1.5 | V |
| | $T_j = 25 \text{ }^\circ\text{C}$ | $I_{TM} = 700 \text{ A}$ | $t = 10 \text{ ms}$ | | 4 | | |
| I_{DRM} | V_{DRM} Specified | | | $T_j = 25 \text{ }^\circ\text{C}$ | | 0.01 | mA |
| | | | | $T_j = 125 \text{ }^\circ\text{C}$ | | 10 | |
| I_{RRM} | V_{RRM} Specified | | | $T_j = 25 \text{ }^\circ\text{C}$ | | 0.01 | mA |
| | | | | $T_j = 125 \text{ }^\circ\text{C}$ | | 10 | |
| t_{gt} | $T_j = 25 \text{ }^\circ\text{C}$ $I_G = 200 \text{ mA}$ | $V_D = V_{DRM}$ $di_G/dt = 1.5 \text{ A}/\mu\text{s}$ | $I_T = 140 \text{ A}$ | | 1 | | μs |
| t_q | $T_j = 125 \text{ }^\circ\text{C}$ $V_D = 67 \% V_{DRM}$ Gate Open | $I_T = 140 \text{ A}$ $di/dt = 30 \text{ A}/\mu\text{s}$ | $V_R = 25 \text{ V}$ $dv/dt = 50 \text{ V}/\mu\text{s}$ | | 50 | | μs |
| dv/dt^* | $T_j = 125 \text{ }^\circ\text{C}$ Linear Slope up to $V_D = 67 \% V_{DRM}$ | Gate Open | | 200 | | | V/ μs |

* For higher guaranteed values, please consult us.

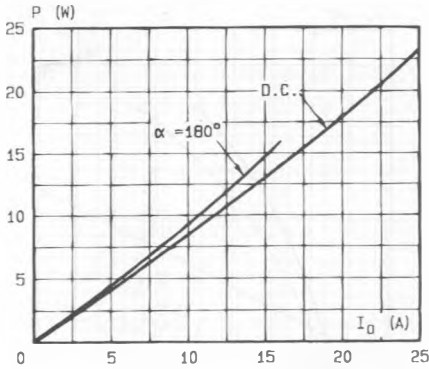


Fig.1 - Maximum average power dissipation versus average on-state current (half sine wave 50 Hz and D.C.).

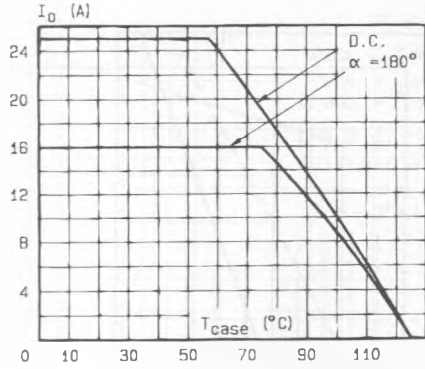


Fig.2 - Maximum average on-state current versus case temperature (half sine wave 50 Hz and D.C.).

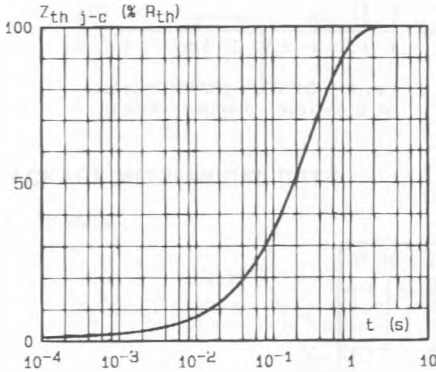


Fig.3 - Thermal transient impedance junction to case versus pulse duration.

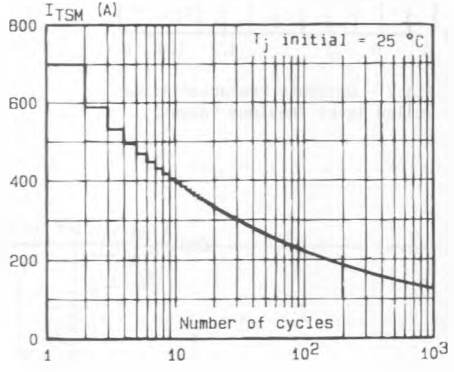


Fig.4 - Non repetitive surge peak on-state current versus number of cycles.

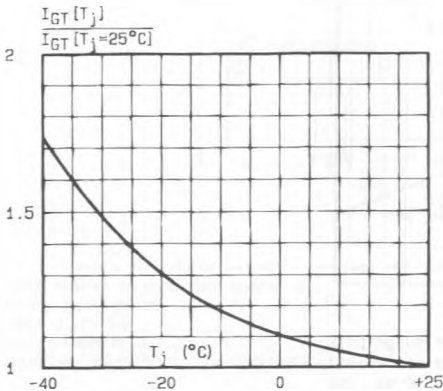


Fig.5 - Relative variation of gate trigger current versus junction temperature.

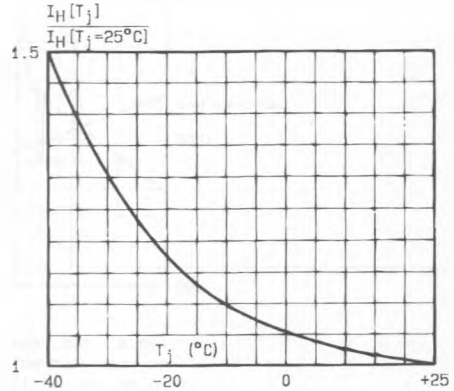


Fig.6 - Relative variation of holding current versus junction temperature.

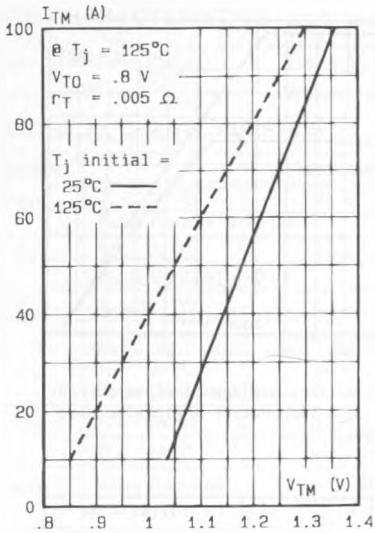


Fig.7 - On-state characteristics at low level (maximum values).

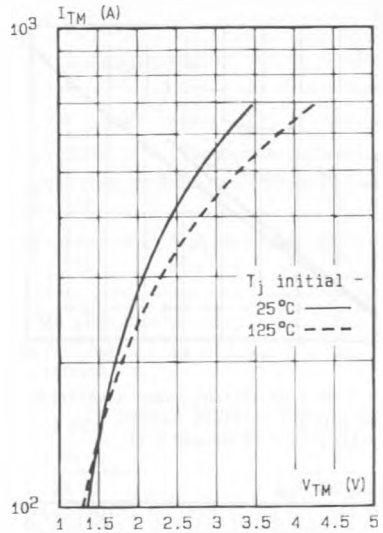


Fig.8 - On-state characteristics at high level (maximum values).

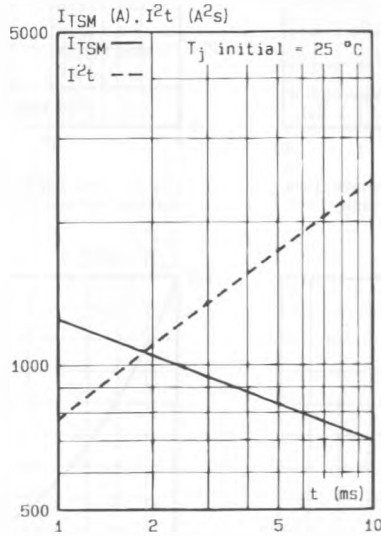


Fig.9 - Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \leq 10 \text{ ms}$, and corresponding value of I^2t .

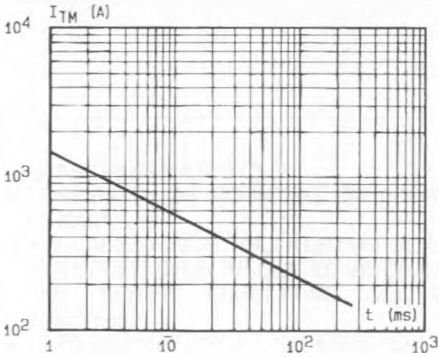


Fig.10 - Peak capacitor discharge current versus pulse width.

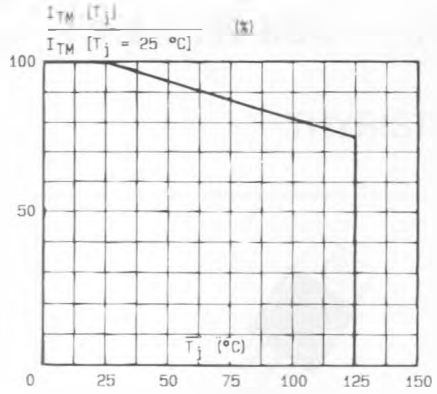
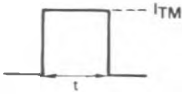
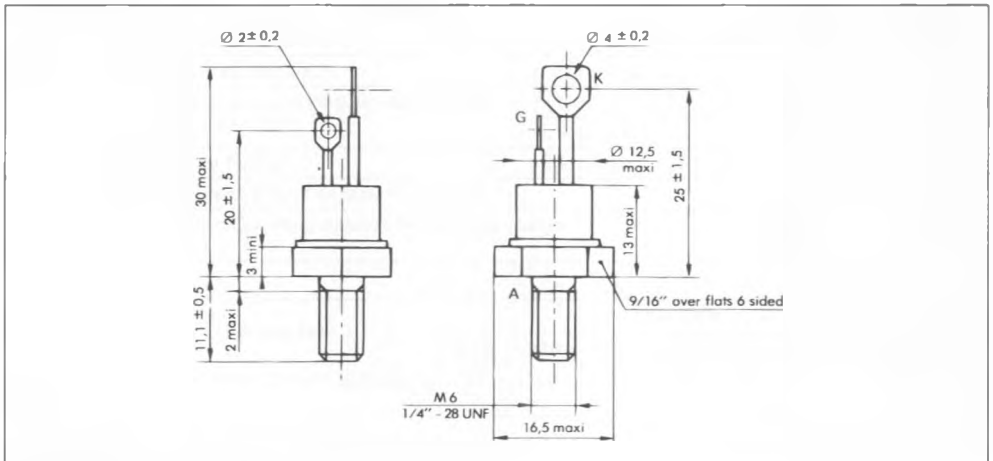


Fig.11 Allowable peak capacitor discharge current versus initial junction temperature.

PACKAGE MECHANICAL DATA

TO 48 Metal



Cooling method : by conduction (method C)
 Marking : type number
 Weight : 13.5 ± 1 g
 Polarity : anode to case
 Stud torque : 3.5 mAN min - 3.8 mAN max